onsemi

Low Capacitance 3 Line EMI Filter with ESD Protection in UDFN8 Package

NUF3102MU

This device is a 3 line EMI filter array for wireless applications. Greater than -25 dB attenuation is obtained at frequencies from 800 MHz to 5.0 GHz. The NUF3102MU has a cut-off frequency of 150 MHz and can be used in applications for data rate up to 58 MHz or 116 Mbps. This UDFN package is specifically designed to enhance EMI filtering for low-profile or slim design electronics especially where space and height is a premium. It also offers ESD protection-clamping transients from static discharges. ESD protection is provided across all capacitors.

Features

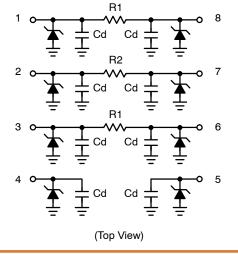
- EMI Filtering and ESD Protection
- Integration of 19 Discrete Components
- Compliance with IEC61000-4-2 (Level 4)
 - > 8 kV (Contact)
 - > 15 kV (Air)
- UDFN Package, 1.2 x 1.8 mm
- Moisture Sensitivity Level 1
- ESD Ratings: Machine Model = C Human Body Model = 3B
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

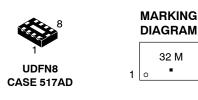
Benefits

- Reduces EMI/RFI Emissions on a Data Line
- Low Profile Package; Typical Height of 0.5 mm
- Design-Friendly and Easy-to-Use Pin Configurations, Particularly for Portable Electronics
- Integrated Solution Offers Cost and Space Savings in UDFN Package
- Reduces Parasitic Inductances Which Offer a More "Ideal" Low Pass Filter Response
- Integrated Solution Improves System Reliability

Applications

- EMI Filtering and ESD Protection for Data Lines
- Keypad Interface and Protection for Portable Electronics
- Bottom Connector Interface for Mobile Handsets
- Notebook Computers and Digital Cameras
- LCD Display Interface in Mobile Handsets
- Camera Display Interface in Mobile Handsets

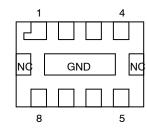




32 = Specific Device Code

- M = Month Code
 - = Pb-Free Package

PIN CONNECTIONS



ORDERING INFORMATION

Device	Package	Shipping [†]
NUF3102MUTAG	UDFN8 (Pb–Free)	3000 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

NUF3102MU

MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
ESD Discharge IEC61000-4-2 Contact Discharge Machine Model Human Body Model	V _{PP}	14 0.4 8.0	kV
Operating Temperature Range	T _{OP}	-40 to 85	°C
Storage Temperature Range	T _{STG}	–55 to 150	°C
Maximum Lead Temperature for Soldering Purposes (1.8 in from case for 10 seconds)	ΤL	260	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

ELECTRICAL CHARACTERISTICS ($T_J = 25^{\circ}C$ unless otherwise noted)

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
Maximum Reverse Working Voltage	V _{RWM}				5.0	V
Breakdown Voltage	V _{BR}	I _R = 1.0 mA	6.0	7.0	8.0	V
Leakage Current	I _R	V _{RWM} = 3.3 V			100	nA
Resistance	R ₁	I _R = 10 mA	85	100	115	Ω
Resistance	R ₂	l _R = 10 mA	40	47	54	Ω
Capacitance (Notes 1 and 2)	Cd	V _R = 2.5 V, f = 1.0 MHz	10	13	16	pF
Cut–Off Frequency (Note 3)	f _{3dB}	Above this frequency, appreciable attenuation occurs		150		MHz

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

1. Measured at 25°C.

2. Total Line Capacitance is two times the Diode Capacitance (Cd).

3. 50 Ω source and 50 Ω load termination.

NUF3102MU



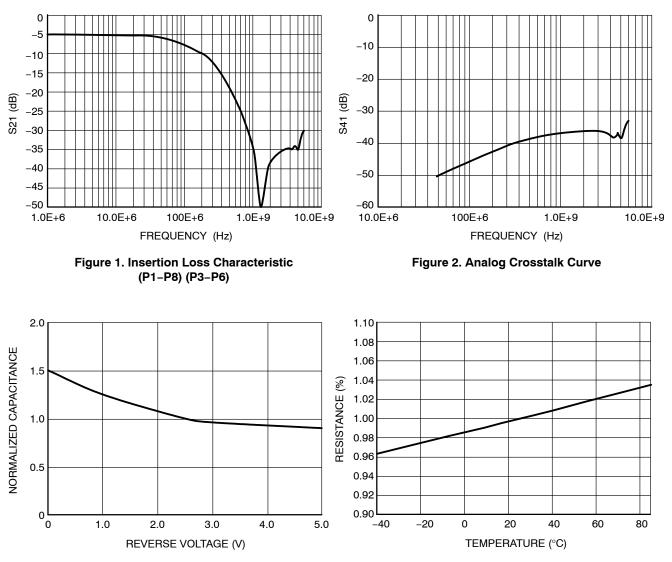
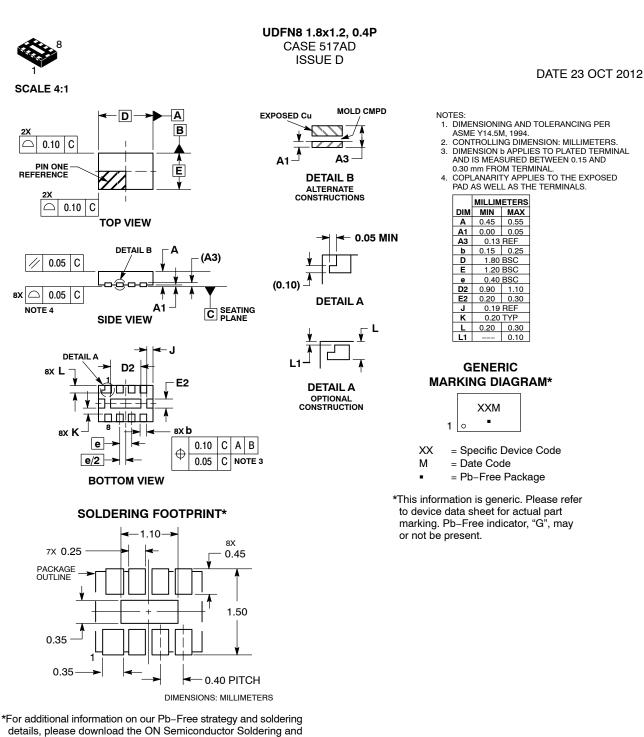




Figure 4. Typical Normalized Resistance over Temperature





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DESCRIPTION:	UDFN8 1.8X1.2, 0.4P		PAGE 1 OF 1	
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